

HiRel Silicon Schottky Diode

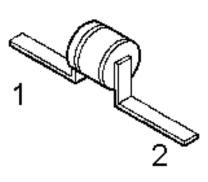
- HiRel Discrete and Microwave Semiconductor
- General-purpose diodes for high-speed switching
- Circuit protection
- Voltage clamping
- High-level detecting and mixing
- Hermetically sealed microwave package
- CSA Space Qualified ESA/SCC Detail Spec. No.: 5512/020 Type Variant No. 01

ESD: Electrostatic discharge sensitive device, observe handling precautions!

Туре	Marking	Ordering Code	Pin Configuration	Package
BAS70-T1 (ql)	-	see below	1-2	T1

(ql) Quality Level: P: Professional Quality H: High Rel Quality S: Space Quality ES: ESA Space Quality

(see order instructions for ordering example)





Maximum Ratings

Parameter	Symbol	Values	Unit
Reverse Voltage	V _R	70	V
Forward Current	I _F	70	mA
Surge Forward Current 1)	I _{FSM}	85	mA
Power Dissipation ²⁾	P _{tot}	250	mW
Operating Temperature Range	T _{op}	-55 to +150	°C
Storage Temperature Range	T _{stg}	-55 to +150	°C
Soldering Temperature ³⁾	T _{sol}	+250	°C
Junction Temperature	Tj	150	°C
Thermal Resistance Junction-Case	R _{th(j-c)}	100	K/W

Electrical Characteristics

at T_A=25°C; unless otherwise specified

Parameter	Symbol		Values		
		min.	typ.	max.	
DC Characteristics					•
Reverse Current 1, V _R =70V	I _{R1}	-	-	2	μΑ
Reverse Current 2, V _R =56V	I _{R2}	-	-	0,1	μA
Forward Voltage 1, I _{F1} =1mA	V _{F1}	0,30	0,38	0,44	V
Forward Voltage 2, I _{F2} =10mA	V _{F2}	0,60	0,70	0,78	V
Forward Voltage 3, I _{F3} =15mA	V _{F3}	0,80	0,85	1,00	V
Differential Forward Resistance 4)	R _{FD}	24	30	32	Ω
IF2=10mA, IF3=15mA					
AC Characteristics	·	÷			•
Total Capacitance	CT	1,2	1,5	2	pF

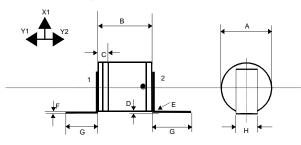
V_R=0V; f=1MHz

Notes.:

1.) t \leq 10ms, Duty Cycle=10%2.) At $T_{CASE} = 125$ °C. For $T_{CASE} > 125$ °C derating is required.3.) During 5 sec. maximum. The same terminal shall not be resoldered until 3 minutes have elapsed.



T1 Package



Symbol	Millimetre		
	min	max	
А	1,30	1,45	
В	1,15	1,35	
С	-	0,40	
D	0,10	0,50	
E	-	0,30	
F	0,06	0,10	
G	5,50	-	
H	0,40	0,60	

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